

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Ho Joon PARK	01/14/2009
Byeung Gyu CHANG	01/14/2009
Hee Ju SON	01/14/2009
Sang Jin KIM	01/14/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRO-MECHANICS CO., LTD.
<b>Street Address:</b>	314, Maetan3-dong, Yeongtong-gu, Suwon,
<b>City:</b>	Gyeonggi-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	12397923
<b>CORRESPONDENCE DATA</b>	
Fax Number:	(202)756-8087
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	202-756-8000
Email:	Kadkins@mwe.com
Correspondent Name:	MCDERMOTT WILL & EMERY LLP
Address Line 1:	600 13TH STREET, N.W.
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20005-3096
ATTORNEY DOCKET NUMBER:	069576-0504
NAME OF SUBMITTER:	Stephen A. Becker

CH \$40.00 12397923

Total Attachments: 3  
 source=0695760504assignmenttransmittal#page1.tif  
 source=0695760504assignment#page1.tif





(SAB)

Docket No.: \_\_\_\_\_

**ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- |                              |           |
|------------------------------|-----------|
| (1) <u>PARK, Ho Joon</u>     | (5) _____ |
| (2) <u>CHANG, Byeung Gyu</u> | (6) _____ |
| (3) <u>SON, Hee Ju</u>       | (7) _____ |
| (4) <u>KIM, Sang Jin</u>     | (8) _____ |

who have made a certain new and useful invention, hereby sell, assign and transfer unto  
SAMSUNG ELECTRO-MECHANICS CO., LTD.

314, Maetan 3-dong, Yeongtong-gu, Suwon, Gyunggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

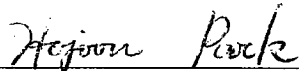
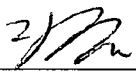
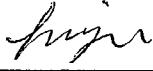

**METHOD OF MANUFACTURING CERAMIC PROBE CARD**

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_,  
and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,  
and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u></u> Name: PARK, Ho Joon	<u>2009. 01. 14</u>
2) <u></u> Name: CHANG, Byeung Gyu	<u>2009. 01. 14</u>
3) <u></u> Name: SON, Hee Ju	<u>2009. 01. 14</u>
4) <u></u> Name: KIM, Sang Jin	<u>2009. 01. 14</u>